

Quectel EG25-G Mini PCIe

IoT/M2M-optimized
LTE Cat 4 Module



Quectel EG25-G Mini PCIe is an LTE category 4 module adopting standard PCI Express® Mini Card form factor (Mini PCIe). It is optimized specially for M2M and IoT applications, and delivers maximum data rates up to 150Mbps downlink and 50Mbps uplink.

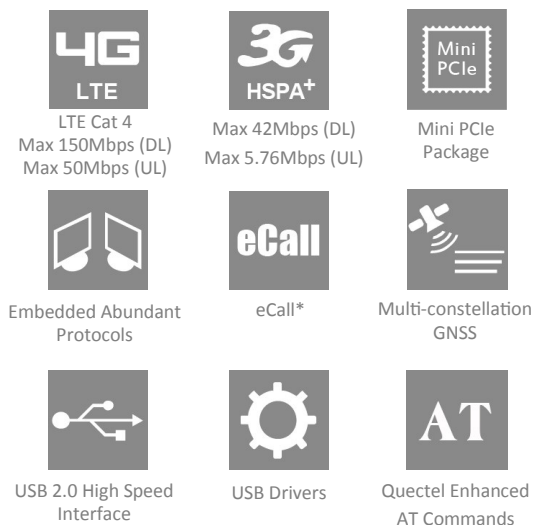
EG25-G Mini PCIe is backward-compatible with existing EDGE and GSM/GPRS networks, ensuring that it can be connected even in remote areas devoid of 4G or 3G coverage.

EG25-G Mini PCIe supports Qualcomm® IZat™ location technology Gen8C Lite (GPS, GLONASS, BeiDou/Compass, Galileo and QZSS). The integrated GNSS greatly simplifies product design, and provides quicker, more accurate and dependable positioning.

A rich set of Internet protocols, industry-standard interfaces and abundant functionalities (USB serial drivers for Windows 7/8/8.1/10, Linux, Android/eCall*) extend the applicability of the module to a wide range of M2M applications such as industrial router, industrial PDA, rugged tablet PC, video surveillance and digital signage, etc.

Key Benefits

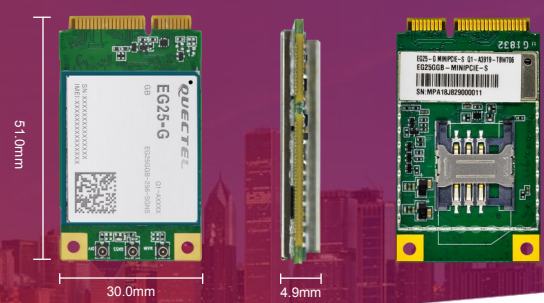
- ✓ LTE category 4 module optimized for broadband IoT applications
- ✓ Worldwide LTE, UMTS/HSPA+ and GSM/GPRS/EDGE coverage
- ✓ Standard PCI Express® Mini Card form factor (Mini PCIe) ideal for manufacturers to easily integrate wireless connectivity into their devices
- ✓ MIMO technology meets demands for data rate and link reliability in modem wireless communication systems
- ✓ Multi-constellation GNSS receiver available for applications requiring fast and accurate fixes in any environment



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Frequency Bands

EG25-G Mini PCIe:

LTE-FDD: B1/B2/B3/B4/B5/B7/B8/B12/B13/B18/
B19/B20/B25/B26/B28

LTE-TDD: B38/B39/B40/B41

WCDMA: B1/B2/B4/B5/B6/B8/B19

GSM: B2/B3/B5/B8

Data

LTE:

LTE-FDD: Max 150Mbps (DL)/Max 50Mbps (UL)

LTE-TDD: Max 130Mbps (DL)/Max 30Mbps (UL)

UMTS:

DC-HSDPA: Max 42Mbps (DL)

HSUPA: Max 5.76Mbps (UL)

WCDMA: Max 384Kbps (DL)/Max 384Kbps (UL)

GSM:

EDGE: Max 296Kbps (DL)/Max 236.8Kbps (UL)

GPRS: Max 107Kbps (DL)/Max 85.6Kbps (UL)

Voice

Speech Codec Modes:

HR/FR/EFR/AMR/AMR-WB

Echo Arithmetic:

Echo Cancellation/Noise Suppression

Audio:

Digital Audio and VoLTE (Voice over LTE)

(Optional)

Interfaces

USB x 1: USB 2.0 with High Speed up to 480Mbps

PCM x 1: Digital Audio through PCM (Optional)

I2C x 1

(U)SIM x 1: 1.8V/3.0V (U)SIM Interface

UART x 1: Main UART

LED_WWAN# for Network Status Indication

W_DISABLE# for Disabling RF Function

PERST# for Module Resetting

Main, Rx-diversity and GNSS Antenna Connectors

Enhanced Features

eCall*

DTMF

Audio Playback/Audio Recording

(U)SIM Card Detection

QuecFile*

(U)SIM Card Connector (Optional) ①

QuecLocator®

Downlink MIMO (Supports Rx-diversity Antenna)

DFOTA:

Delta Firmware Upgrade Over-The-Air

GNSS:

GPS/GLONASS/BeiDou (Compass)/Galileo/QZSS

(Optional)

Electrical Characteristics

Output Power:

Class 3 (23dBm±2dB) for LTE-FDD bands

Class 3 (23dBm±2dB) for LTE-TDD bands

Class 3 (24dBm+1/-3dB) for WCDMA bands

Class E2 (27dBm±3dB) for GSM850 8-PSK

Class E2 (27dBm±3dB) for EGSM900 8-PSK

Class E2 (26dBm±3dB) for DCS1800 8-PSK

Class E2 (26dBm±3dB) for PCS1900 8-PSK

Class 4 (33dBm±2dB) for GSM850

Class 4 (33dBm±2dB) for EGSM900

Class 1 (30dBm±2dB) for DCS1800

Class 1 (30dBm±2dB) for PCS1900

Consumption:

3.6mA @Sleep, Typ.

35mA @Idle

Sensitivity:

LTE B1: -99.5 (10MHz)

LTE B2: -99.9dBm (10MHz)

LTE B3: -99.7dBm (10MHz)

LTE B4: -99.7dBm (10MHz)

LTE B5: -99.9dBm (10MHz)

LTE B7: -99.2dBm (10MHz)

LTE B8: -99.8dBm (10MHz)

LTE B12: -99.8dBm (10MHz)

LTE B13: -99.5dBm (10MHz)

LTE B18: -100dBm (10MHz)

LTE B19: -99.9dBm (10MHz)

LTE B20: -99.8dBm (10MHz)

LTE B25: -100dBm (10MHz)

LTE B26: -99.5dBm (10MHz)

LTE B28: -99.6dBm (10MHz)

LTE B38: -99dBm (10MHz)

LTE B39: -99.5dBm (10MHz)

LTE B40: -99.2dBm (10MHz)

LTE B41: -99dBm (10MHz)

WCDMA B1: -109.2dBm

WCDMA B2: -110dBm

WCDMA B4: -109.7dBm

WCDMA B5: -110.4dBm

WCDMA B6: -110.5dBm

WCDMA B8: -110.5dBm

WCDMA B19: -110.1dBm

GSM850: -108dBm

EGSM900: -108dBm

DCS: -107.5dBm

PCS: -107.5dBm

Software Features

USB Serial Driver:

Windows 7/8/8.1/10,

Linux 2.6~5.4,

Android 4.x/5.x/6.x/7.x/9.x

GNSS Driver:

Android 4.x/5.x/6.x/7.x/8.x/9.x

RIL Driver:

Android 4.x/5.x/6.x/7.x/8.x/9.x

NDIS Driver:

Windows 7/8/8.1/10

MBIM Driver:

Windows 8/8.1/10, Linux 3.18~5.4

GobiNet Driver:

Linux 2.6~5.4

QMI_WWAN Driver:

Linux 2.6~5.4

Protocols:

TCP/UDP/PPP/FTP/HTTP/NTP/PING/QMI/NITZ/
SMTP/MQTT/CMUX/HTTPS/FTPS/SMT/SSL/
MMS*/FILE*

General Features

Operation Temperature Range: -35°C ~ +75°C

Extended Temperature Range: -40°C ~ +80°C

Dimensions: 51.0mm x 30.0mm x 4.9mm

Weight: Approx. 9.8g

Mini PCIe Package

Supply Voltage: 3.0V~3.6V, 3.3V Typ.

3GPP E-UTRA Release 11

Bandwidth: 1.4/3/5/10/15/20MHz

3GPP TS27.007 and Enhanced AT Commands

Approvals

Carrier:

Deutsche Telekom (Europe)

Verizon/AT&T/U.S. Cellular/T-Mobile*/Sprint*

(North America)

Telus/Rogers* (Canada)

Regulatory:

GCF (Global)

CE (Europe)

FCC/PTCRB (North America)

IC (Canada)

Anatel (Brazil)

IFETEL (Mexico)

SRRC/CCC/NAL (China)

KC (South Korea)

NCC (Taiwan, China)

JATE/TELEC (Japan)

RCM (Australia & New Zealand)

FAC* (Russia)

NBTC* (Thailand)

IMDA (Singapore)

ICASA (South Africa)

Others:

RoHS

WHQL

* Under Development

① There are two types of EG25-G Mini PCIe, with or without (U)SIM card connector.